BS170

Preferred Device

Small Signal MOSFET 500 mA, 60 V

N-Channel TO-92 (TO-226)

Features

• Pb-Free Package is Available*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	60	Vdc
Gate–Source Voltage – Continuous – Non–repetitive (t _p ≤ 50 μs)	V _{GS} V _{GSM}	±20 ±40	Vdc Vpk
Drain Current (Note)	Ι _D	0.5	Adc
Total Device Dissipation @ $T_A = 25^{\circ}C$	PD	350	mW
Operating and Storage Junction Temperature Range	T _J , T _{stg}	–55 to +150	°C

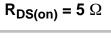
1. The Power Dissipation of the package may result in a lower continuous drain current.

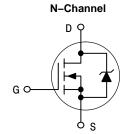


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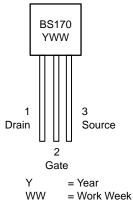
500 mA, 60 V







MARKING DIAGRAM & PIN ASSIGNMENT



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

Preferred devices are recommended choices for future use and best overall value.

BS170

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS				•	
Gate Reverse Current (V _{GS} = 15 Vdc, V _{DS} = 0)	I _{GSS}	-	0.01	10	nAdc
Drain–Source Breakdown Voltage $(V_{GS} = 0, I_D = 100 \ \mu Adc)$	V _{(BR)DSS}	60	90	-	Vdc
ON CHARACTERISTICS (Note 1)				•	
Gate Threshold Voltage $(V_{DS} = V_{GS}, I_D = 1.0 \text{ mAdc})$	V _{GS(Th)}	0.8	2.0	3.0	Vdc
Static Drain–Source On Resistance $(V_{GS} = 10 \text{ Vdc}, I_D = 200 \text{ mAdc})$	r _{DS(on)}	_	1.8	5.0	Ω
Drain Cutoff Current (V _{DS} = 25 Vdc, V _{GS} = 0 Vdc)	I _{D(off)}	-	-	0.5	μΑ
Forward Transconductance $(V_{DS} = 10 \text{ Vdc}, I_D = 250 \text{ mAdc})$	9fs	_	200	-	mmhos
SMALL-SIGNAL CHARACTERISTICS			-	-	-
Input Capacitance (V _{DS} = 10 Vdc, V _{GS} = 0, f = 1.0 MHz)	C _{iss}	-	-	60	pF
SWITCHING CHARACTERISTICS					
Turn–On Time (I _D = 0.2 Adc) See Figure 1	t _{on}	-	4.0	10	ns
Turn–Off Time (I _D = 0.2 Adc) See Figure 1	t _{off}	_	4.0	10	ns

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

1. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%.

ORDERING INFORMATION

Device	Package	Shipping [†]	
BS170	TO-92 (TO-226)	1000 Unit / Box	
BS170G	TO-92 (TO-226) (Pb-Free)	1000 Unit / Box	
BS170RLRA		2000 Tape & Reel	
BS170RLRM		2000 Tape & Ammo Box	
BS170RLRP	TO-92 (TO-226)	2000 Tape & Ammo Box	
BS170RL1		2000 Tape & Reel	
BS170ZL1		2000 Tape & Ammo Box	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

BS170

RESISTIVE SWITCHING

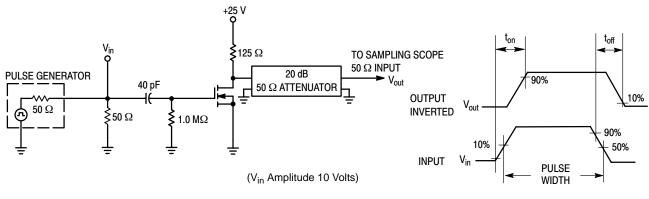
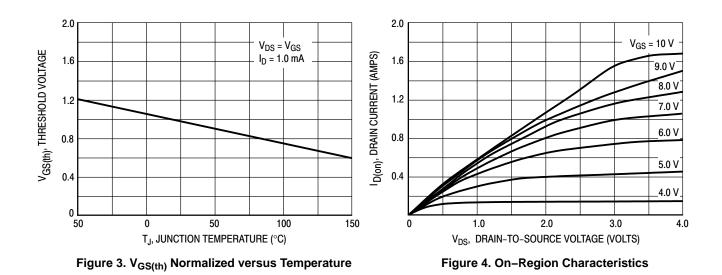
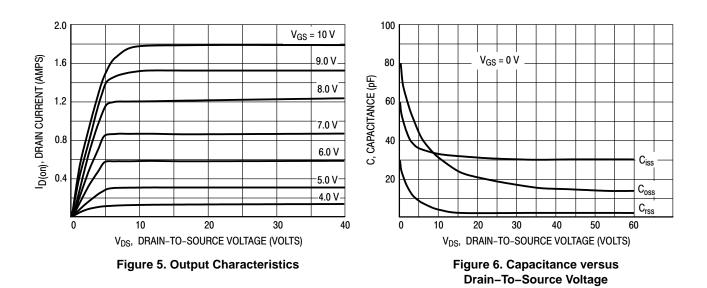


Figure 1. Switching Test Circuit

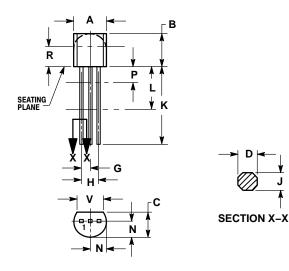
Figure 2. Switching Waveforms





PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 ISSUE AL



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.
- 3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
- LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	ETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.175	0.205	4.45	5.20	
В	0.170	0.210	4.32	5.33	
С	0.125	0.165	3.18	4.19	
D	0.016	0.021	0.407	0.533	
G	0.045	0.055	1.15	1.39	
Η	0.095	0.105	2.42	2.66	
J	0.015	0.020	0.39	0.50	
Κ	0.500		12.70		
L	0.250		6.35		
Ν	0.080	0.105	2.04	2.66	
Ρ		0.100		2.54	
R	0.115		2.93		
٧	0.135		3.43		

STYLE 30: PIN 1. DRAIN 2. GATE 3. SOURCE

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